

LEADER TIME SRL

PRODUCT SPECIFICATION

16*2 Characters COB LCD MODULE MODEL: LT-1602F1-291 Ver:3.0

< >> Finally Specification

| CUSTOMER'S APPROVAL | | | | | |
|---------------------|-------|--|--|--|--|
| CUSTOMER: | | | | | |
| NATURE: | DATE: | | | | |
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Prepared By: LEADER TIME SRL VIA MONS. PROSDOCIMI, 27

36042 BREGANZE (VI)

I This specification is subject to change without notice. Please contact LT or it's representative before designing your product based on this specification.

Revision Status

| Version | Revise Date | Page | Content | Modified By |
|---------|-------------|------|--------------|-------------|
| VER 3.0 | 2010/5/25 | | First Issued | |
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Model No.: LT-1602F1-291 **Ver:**3.0

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1. FEATURES

The features of LCD are showed as follows

* Display mode : STN/Yellow-Green/Transflective/Positive

* Controller IC : ST7066U-0A(English and Japanese)

* Display format : 16X2Characters * Interface : 4 Bit or 8 Bit MPU * Driving Method : 1/16Duty, 1/5Bias

* Viewing Direction : 60'clock

* Backlight : LED Yellow-Green (Side)

*Sample NO. : EC1602C5SBX6B-3.0/20100512

2. MECHANICAL SPECIFICATIONS

| Item | Specification | Unit |
|-----------------------------------|---------------------------|------|
| Module Size | 80 (W) x 36(H) x9.5Max(T) | mm |
| Viewing Area | 64.5 (W) x 16(H) | mm |
| Activity Display Area | y Area 56.21(W)x11.5(H) r | |
| Character Font | 5x8 Dots | - |
| Character Size | 2.96(W)x5.56(H) | mm |
| Character Pitch 3.55 (W) x5.94(H) | | mm |
| Dot Size | 0.56(W)x0.66(H) | mm |

3. ELECTRICAL SPECIFICATIONS

3-1 ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

| Item | Symbol | Min | Max | Unit |
|------------------------------|-----------|--------|----------------------|------|
| Supply Voltage For Logic | Vdd | -0.3 | 7.0 | V |
| Supply Voltage For LCD Drive | V_{LCD} | VDD-10 | V _{DD} +0.3 | V |
| Input Voltage | Vin | -0.3 | V _{DD} +0.3 | V |
| Operating Temp. | Тор | -20 | +70 | °C |
| Storage Temp. | Tst | -30 | +80 | °C |

^{*.} NOTE: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

3-2 ELECTRICAL CHARACTERISTICS

| Item | Item | | Test Condition | Min. | Тур. | Max. | Unit |
|----------------------|-----------|-----------------------------------|---------------------------|---------|------|------|------|
| Logic supply Voltage | | V _{DD} – V _{ss} | | 4.5 | 5 | 5.5 | V |
| LCD Di | LCD Drive | | | 4.0 | 4.3 | 4.6 | V |
| Input Voltage | "H" Level | V _{IH} | Ta = 25 °C | 0.7 Vdd | - | VDD | V |
| | "L" Level | V _{IL} | V _{DD} =5V ± 10% | -0.3 | - | 0.6 | V |
| Frame Frequency | | f _{FLM} | | ı | 84.7 | - | Hz |
| Current Cons | sumption | I _{DD} | | - | 1.4 | - | mA |

3-3 BACKLIGHT

3-3-1. Absolute Maximum Ratings

| Item | Symbol | Condition | Min. | Тур. | Max. | Unit |
|-------------------|--------|------------|------|------|------|------|
| Forward Current | IF | | - | - | 15*2 | mA |
| Reverse Voltage | VR | Ta = 25 °C | - | - | 5 | V |
| Power Dissipation | PD | | - | - | 69*2 | mW |

3-3-2. Electrical-optical Characteristics

| Item | Symbol | Condition | Min. | Тур. | Max. | Unit |
|----------------------------|--------|----------------------------|------|------|------|-------------------|
| Forward Voltage | VF | | 3.8 | 4.2 | 4.6 | V |
| Average Luminous Intensity | lv | Iv If=15*2mA Ta = 25 °C | | - | - | cd/m ² |
| Peak wave length | λр | 1a - 25 O | 567 | 572 | 577 | nm |

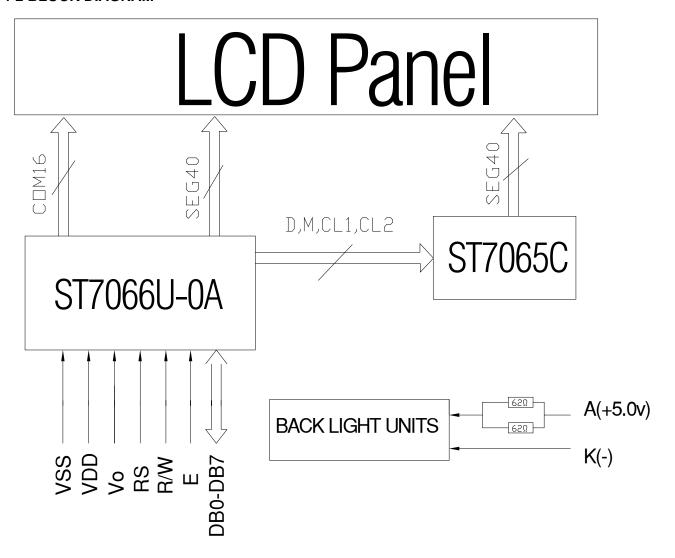
The brightness is measured without LCD panel

4. TERMINAL FUNCTIONS AND BLOCK DIAGRAM

4-1 INTERFACE PIN FUNCTION DESCRIPTION

| PIN NO. | SYMBOL | FUNCIONS |
|---------|---------|-----------------------------------------------------------------|
| 1 | VSS | Ground |
| 2 | VDD | Supply voltage for logical circuit |
| 3 | V0 | Supply voltage for LCD driving |
| 4 | RS | A signal for selecting registers. |
| 5 | R/W | A signal for selecting read or write actions.1: Read, 0: Write. |
| 6 | E | Read / Write enable signal |
| 7-14 | DB0~DB7 | Data Bus |
| 15 | K | Backlight (-) |
| 16 | Α | Backlight (+5.0V) |

4-2 BLOCK DIAGRAM



5. TIMING CHARACTERISTICS

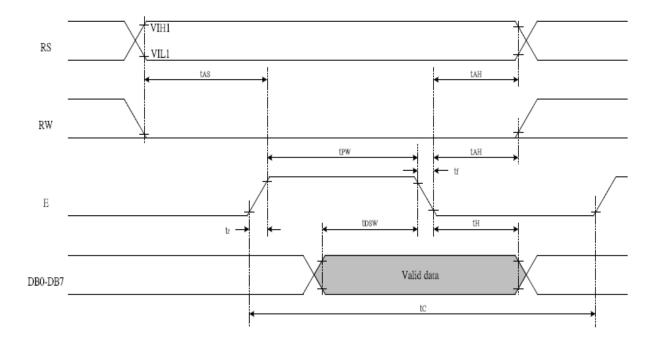
5-1 Write mode

| T _C | Enable Cycle Time | Pin E | 1200 | - | - | ns |
|------------------|-----------------------|-----------------|------|---|-----|----|
| T_PW | Enable Pulse Width | Pin E | 140 | 1 | - | ns |
| T_R, T_F | Enable Rise/Fall Time | Pin E | - | - | 25 | ns |
| T _{AS} | Address Setup Time | Pins: RS,RW,E | 0 | - | - | ns |
| T _{AH} | Address Hold Time | Pins: RS,RW,E | 10 | - | - | ns |
| T _{DDR} | Data Setup Time | Pins: DB0 - DB7 | - | - | 100 | ns |
| T _H | Data Hold Time | Pins: DB0 - DB7 | 10 | - | - | ns |

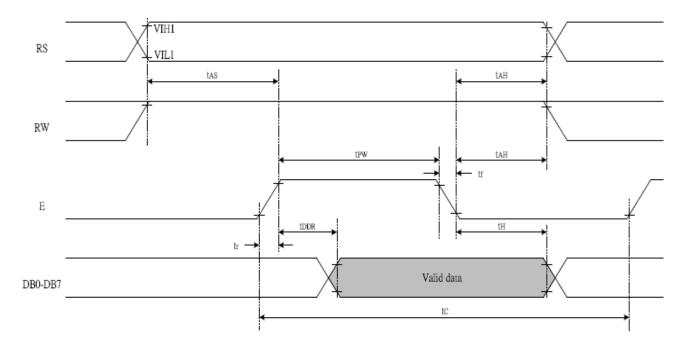
5-2 Read mode

| T _C | Enable Cycle Time | Pin E | 1200 | - | - | ns |
|------------------|-----------------------|-----------------|------|---|-----|----|
| T_PW | Enable Pulse Width | Pin E | 140 | - | - | ns |
| T_R, T_F | Enable Rise/Fall Time | Pin E | - | - | 25 | ns |
| T _{AS} | Address Setup Time | Pins: RS,RW,E | 0 | - | - | ns |
| T _{AH} | Address Hold Time | Pins: RS,RW,E | 10 | - | - | ns |
| T _{DDR} | Data Setup Time | Pins: DB0 - DB7 | - | - | 100 | ns |
| T _H | Data Hold Time | Pins: DB0 - DB7 | 10 | - | - | ns |

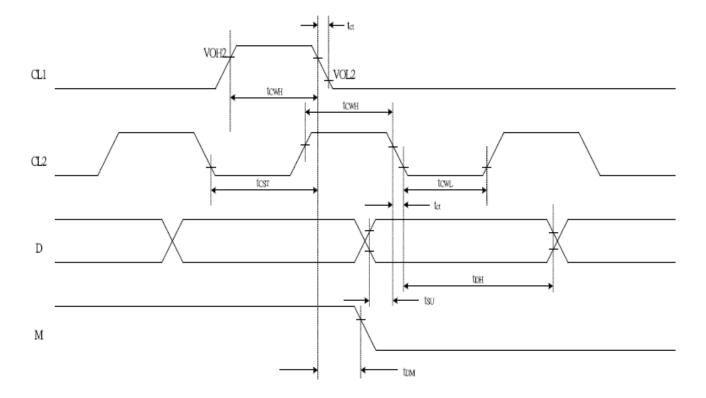
5-3 Write timing mode diagram



5.4 Read timing mode diagram



5-5 Interface timing mode



6. COMMAND LIST

6-1 Instruction Table

| -1 mstruction | | | | Inst | ructi | on C | Code | , | | | | Description | |
|----------------------------------|----|-----|-----|------|-------|------|------|----------|-----|-----|----------------------------------------------------------------------------------------------------------------------------------------------|------------------|--|
| Instruction | RS | R/W | DB7 | DB6 | | DB4 | | DB2 | DB1 | DB0 | Description | Time (270KHz) | |
| Clear Display | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | Write "20H" to DDRAM. and set DDRAM address to "00H" from AC | 1.52 ms | |
| Return Home | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | x | Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed. | 1.52 ms | |
| Entry Mode Set | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | I/D | s | Sets cursor move direction and specifies display shift. These operations are performed during data write and read. | 37 us | |
| Display ON/OFF | 0 | 0 | 0 | 0 | 0 | 0 | 1 | D | С | В | D=1:entire display on C=1:cursor on B=1:cursor position on | 37 us | |
| Cursor or Display Shift | 0 | 0 | 0 | 0 | 0 | 1 | S/C | R/L | х | x | Set cursor moving and display shift control bit, and the direction, without changing DDRAM data. | 37 us | |
| Function Set | 0 | 0 | 0 | 0 | 1 | DL | N | F | х | х | DL:interface data is 8/4 bits N:number of line is 2/1 F:font size is 5x11/5x8 | 37 us | |
| Set CGRAM address | 0 | 0 | 0 | 1 | AC5 | AC4 | AC3 | AC2 | AC1 | AC0 | Set CGRAM address in address counter | 37 us | |
| Set DDRAM address | 0 | 0 | 1 | AC6 | AC5 | AC4 | AC3 | AC2 | AC1 | AC0 | Set DDRAM address in address counter | 37 us | |
| Read Busy flag and address | 0 | 1 | BF | AC6 | AC5 | AC4 | AC3 | AC2 | AC1 | AC0 | Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read. | 0 us | |
| Write data to RAM | 1 | 0 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Write data into internal RAM (DDRAM/CGRAM) | 37 us | |
| Read data from RAM | 1 | 1 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Read data from internal RAM (DDRAM/CGRAM) | 37 us | |

Note:

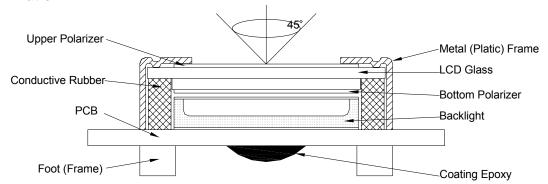
Be sure the ST7066U is not in the busy state (BF = 0) before sending an instruction from the MPU to the ST7066U. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to Instruction Table for the list of each instruction execution time.

7. CHARACTER GENERATOR ROM

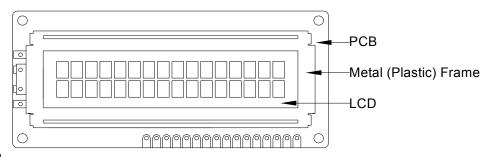
| | NO.7066-0A | | | | | | | | | | | | | | | |
|----------------|------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| 67-64 63-60 | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
| 0000 | CG RAM (1) | | | | | | | | | | | | | | | |
| 0001 | (2) | | | | | | | | | | | | | | | |
| 0010 | (3) | | | | | | | | | | | | | | | |
| 0011 | (4) | | | | | | | | | | | | | | | |
| 0100 | (5) | | | | | | | | | | | | | | | |
| 0101 | (6) | | | | | | | | | | | | | | | |
| 0110 | (7) | | | | | | | | | | | | | | | |
| 0111 | (8) | | | | | | | | | | | | | | | |
| 1000 | (1) | | | | | | | | | | | | | | | |
| 1001 | (2) | | | | | | | | | | | | | | | |
| 1010 | (3) | | | | | | | | | | | | | | | |
| 1011 | (4) | | | | | | | | | | | | | | | |
| 1100 | (5) | | | | | | | | | | | | | | | |
| 1101 | (6) | | | | | | | | | | | | | | | |
| 1110 | 7) | | | | | | | | | | | | | | | |
| 1111 | (8) | | | | | | | | | | | | | | | |

8. QUALITY SPECIFICATIONS

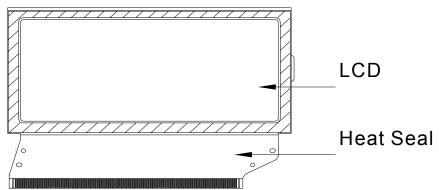
- 8 1. LCM Appearance and Electric inspection Condition
- 1. Inspection will be done by placing LCM 30cm away from inspector's eyeballs under normal illumination.



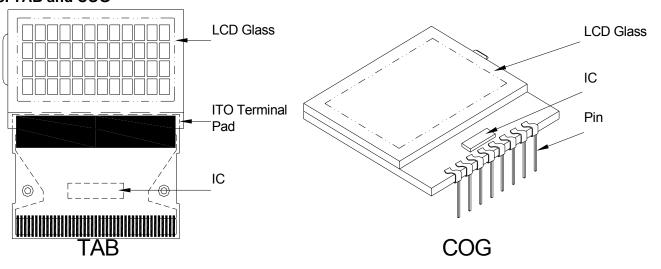
- 2. View Angle: with in 45° around perpendicular line.
- 8- 2. Definition
- 1. COB



2. Heat Seal



3. TAB and COG



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8-3. Sampling Plan and Acceptance

1.Sampling Plan

MIL - STD - 105E (||) ordinary single inspection is used.

2.Acceptance

Major defect: AQL = 0.25%Minor defect: AQL = 0.65%

8-4. Criteria

1.COB

| Defect | Inspection Item | Inspection Standards | |
|--------|-------------------------------|----------------------------------------------------------------------------|--------|
| Major | PCB copper flakes peeling off | Any copper flake in viewing Area should be greater than 1.0mm ² | Reject |
| Major | Height of coating epoxy | Exceed the dimension of drawing | Reject |
| Major | Void or hole of coating epoxy | Expose bonding wire or IC | Reject |
| Major | PCB cutting defect | Exceed the dimension of drawing | Reject |

2.SMT

| Defect | Inspection Item | Inspection Standa | ards |
|--------|-------------------------------------------------------------------------------|---------------------------------|--------|
| Minor | Component marking not readable | | Reject |
| Minor | Component height | Exceed the dimension Of drawing | Reject |
| Major | Component solder defect (missing, extra, wrong component or wrong orientation | | Reject |
| Minor | Component position shift component soldering pad X D Y | X < 3/4Z Y > 1/3D | Reject |
| Minor | Component tilt component soldering pad | Y > 1/3D | Reject |
| Minor | Insufficient solder component PAD | θ <u><</u> 20° | Reject |

3. Metal (Plastic) Frame

| Defect | Inspection Item | lı | Inspection Standards | | | |
|--------|--------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|---------------------------------|--|--|
| Major | Crack / breakage | Any | ywhere | Reject | | |
| | | W | L | Acceptable of Scratch | | |
| | | w<0.1mm | Any | Ignore | | |
| | | 0.1 <u><</u> w<0.2mm | L <u><</u> 5.0mm | 2 | | |
| Minor | Frame Scratch | 0.2 <u><</u> w<0.3mm | L <u><</u> 3.0mm | 1 | | |
| | | w <u>></u> 0.3mm | Any | 0 | | |
| | | Note: 1. Above criteria applicable to scratch line with distance greater than 5mm. 2. Scratch on the back side of frame (no visible) can be ignored. | | | | |
| | | | | Acceptable of Dents / Pricks | | |
| | | Ф <u><</u> 1.0mm | | 2 | | |
| | Frame Dent , Prick | 1.0<4 | 1 | | | |
| Minor | $\Phi = \frac{L + M}{2}$ | 1.5 | 0 | | | |
| | 2 | Note: 1. Above criteria applicable to any two dents / pricks with distance greater than 5mm 2. Dent / prick on the back side of frame (no visible) can be ignored | | | | |
| Minor | Frame Deformation | Exceed the dimension of drawing | | | | |
| Minor | Metal Frame Oxidation | | Any rust | | | |

4. Flexible Film Connector (FFC)

| 4. Flexible F | Inspection Item | | Inspection Standards | | |
|---------------|------------------|-------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------|--------|------------|
| Minor | Tilted soldering | | Tilted soldering Within the angle +5° | | Acceptable |
| Minor | Uneven s | older joint /bump | | Reject | |
| | | | Expose the conductive line | Reject | |
| Minor | Hole | $\Phi = \frac{L + W}{2}$ | Φ > 1.0mm | Reject | |
| Minor | Position shift | | Y > 1/3D | Reject | |
| IVIII IOI | | - - | X > 1/2Z | Reject | |

5. Screw

| 2. 0.1. | | | | | | | |
|----------------------------|-------------------|----------------------------------|--------|--|--|--|--|
| Defect Inspection Item | | Inspection Standards | | | | | |
| Major Screw missing/loosen | | | Reject | | | | |
| Minor | Screw oxidation | Any rust | Reject | | | | |
| Minor | Screw deformation | Difficult to accept screw driver | Reject | | | | |

6. Heatseal 、TCP 、FPC

| Defect | Inspection Item | Inspection Standards | |
|----------|----------------------------------|-----------------------------|--------|
| Major | Scratch expose conductive layer | | Reject |
| Minor | HS Hole $\Phi = \frac{L + W}{2}$ | Ф> 0.5mm | Reject |
| Major | Adhesion strength | Less than the specification | Reject |
| Minor | Position shift | Y > 1/3D | Reject |
| IVIIIIOI | X X | X > 1/2Z | Reject |
| Major | Conductive line break | | Reject |

7. LED Backing Protective Film and Others

| Defect | Inspection Item | Inspection Standards | | | | |
|--------|----------------------|--------------------------------------------------------------------------------------------------------------|--------|--|--|--|
| | | Acceptable number of units | | | | |
| | | Ф <u><</u> 0.10mm | ignore | | | |
| | | 0.10<Φ <u><</u> 0.15mm | 2 | | | |
| Minor | LED dirty, prick | 0.15<Φ <u><</u> 0.2mm | 1 | | | |
| | | Ф>0.2mm | 0 | | | |
| | | The distance between any two spots should be ≥5mm Any spot/dot/void outside of viewing area is acceptable | | | | |
| Minor | Protective film tilt | Not fully cover LCD Reje | | | | |
| Major | COG coating | Not fully cover ITO circuit Reject | | | | |

8. Electric Inspection

| Defect | Inspection Item | Inspection Standards | |
|--------|-----------------|----------------------|--------|
| Major | Short | | Reject |
| Major | Open | | Reject |

9. Inspection Specification of LCD

| Defect | Insp | ect Item | | Inspection Standards | | | | | |
|---------------------|-------------------------------|---------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------|----------------------------------|---------------------------------------------------------|------------------------|------|---------|
| | | * Glass Scratch | W | _ | 0.03 | 0.0 | 0.0 <u><</u> W>0 | 5 \ | V>0.05 |
| | | * Polarizer Scratch | L | L | <5 | | L<3 | | Any |
| Minor Linear Defect | | * Fiber and Linear | ACC. NO. | 1 | | | 1 | | Reject |
| | | material | Note | L is the length and W | | | is the width of the de | | efect |
| | | * Foreign material | | Ф <u><</u> 0.1 | 0.1<Φ <u><</u> 0 | .15 | 0.15<Ф <u><</u> 0. | .2 | Ф>0.2 |
| | Black Spot and | | ACC. NO. | 3EA / 100mm ² | 2 | | 1 | | 0 |
| Minor | Polarizer Pricked | and glass * Polarizer hole or protuberance by external force | Note | Φ is the average diameter of the defect. Distance between two defects > 10mm. | | | | | |
| | | * Unobvious | Φ | Ф <u><</u> | 0.3 | 0.3 | <Ф <u><</u> 0.5 | 0 | .5<Ф |
| | White Spot | transparent foreign material between | | 3EA / 1 | 00mm ² | | 1 | | 0 |
| Minor | and Bubble in polarizer | glass and glass or glass and polarizer * Air protuberance between polarizer and glass | | | | age diameter of the defect. ween two defects > 10mm. | | | |
| | | | Φ | Ф <u><</u> 0.10 | 0.10<Φ <u><</u> | 0.20 | 0.20<Φ <u><</u> | 0.25 | Ф>0.25 |
| | | w | | 3EA / 100mm ² | 3EA / 100mm ² 2 | | 1 | | 0 |
| Minor | Segment Defect | -W- | | W is more | than 1/2 s | egme | ent width | | Reject |
| | 20.00. | | Note | $\Phi = \frac{L + W}{2}$ Distance between two defect is 10mm | | | | | |
| | | | Ф | Φ <u><</u> 0.10 | 0.10<Ф< | 0.20 | 0.20<Ф< | 0.25 | Ф>0.25 |
| | Protuberant | w w | W | Glue | ue W <u><</u> 1/2 So W<0.2 | | | | Ignore |
| Minor | Segment | $\Phi = (L + W)/2$ | ACC. NO. | 3EA / 100mm² | 2 | | 1 | | 0 |
| | | | 1. Seg | ment | ı | | • | | |
| | | | Е | | <u><</u> 0.4mm | | 3 <u><</u> 1.0mm | B> | 1.0mm |
| Minor | Assembly | | B- | A B- | A<1/2B | B- | A<0.2 | B-A | N<0.25 |
| | Mis-alignment | | Jud | | | Acc | Acceptable Acce | | eptable |
| | | | 2. Dot Matrix | | | | | | |
| | | | | rmation>2° | | | | | Reject |
| Minor | Stain on LCD Panel Surface | | Accept when stains can be wiped lightly with a soft clot or a similar one. Otherwise, judged according to the above items: "Black spot" and "White Spot" | | | | | | |

9. RELIABILITY

| NO. | Item | Condition | Criterion | |
|-----|----------------------------|-------------------------------------------------------|--------------------------------------------------------------------|--|
| 1 | High Temperature Operating | 70℃, 96Hrs | | |
| 2 | Low Temperature Operating | -20℃, 96Hrs | | |
| 3 | High Humidity | 60℃, 90%RH, 96Hrs | | |
| 4 | High Temperature Storage | 80℃, 96Hrs | | |
| 5 | Low Temperature Storage | -30℃, 96Hrs | No defect in cosmetic and | |
| | | Random wave | operational function allowable. | |
| 6 | Vibration | 10 ~ 100Hz | Total current Consumption should be below double of initial value. | |
| 0 | VIDIALIOII | Acceleration: 2g | | |
| | | 2 Hrs per direction(X,Y,Z) | | |
| | | -20℃ to 25℃ to 70℃ | | |
| 7 | Thermal Shock | (60Min) (5Min) (60Min) | | |
| | | 16Cycles | | |
| 8 | ESD Testing | Contract Discharge Voltage: +1 ~ 5kV and –1 ~ –5kV | There will be discharged ten times at every discharging | |
| O | Lob resulty | Air Discharge Voltage: +1 ~ 8kV and –1 ~ -8kV | voltage cycle. The voltage gap is 1kV. | |

Note: 1) Above conditions are suitable for standard products.

²⁾ For restrict products, the test conditions listed as above must be revised.

10. HANDLING PRECAUTION

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers, which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Tricolor trifler thane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

- Water
- Kenton
- Aromatics
- (3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

(4) Packaging

- Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.
- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.

(5) Caution for operation

- It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's .which will come back in the specified operating temperature range.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- -A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the relative condition of 40°C, 50%RH or less is required.

(6) Storage

In the case of storing for a long period of time, (For years) for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.
- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

(7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol. Which should be burned up later. When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

Issued Date: 2010/5/25 Doc. No.: 11. OUTLINE DIMENSION $\overline{<}$ \Box \bigcirc out shine Dutline assignment DB6 DB2 $\overline{DB3}$ DB4 DB2 DB0 <u>DB1</u> RS $\overline{\text{DB7}}$ 9 9 E prevent 9 9 ∞ Ľ, 13 7 RE(to $_{\odot}$ Add black film REVISION Changed the 1.2 Changed the 2010.05.04 Issue DRAWN 3.55 2.96 $\Box\Box$ $-\Box$ First \Box LC. VERSION 1/1 CHECKED 9.5 MAX 99.0 0.56 6±0. 7.0 95.6 APPROVED $4-\phi 2.5$ **₹6.8** \bigcirc d 2.5 2.5 9 G.0±δ V.A 64.5±0. A.A(56.21 80 ± 0.3 Viewing direction $69.4\pm0.$ 75±0. $\mathbb{P}^{2}.54 \times 15 = 38.1 (W=2)$ $16-\phi1.00$ P2.54X15=38.1(W=2) $16 - \emptyset 1.00$ ∞ ∞ (3.11)A.A S.0±81 A.V Z.0±4.4⊆ 5.0 ± 15 Σ.0±∂δ \Box